MOSFET – Power -60 V, -20 A, 52 m Ω

Features

- Low R_{DS(on)}
- · Fast Switching
- These Devices are Pb-Free and are RoHS Compliant

Applications

- Load Switches
- DC Motor Control
- DC-DC Conversion

MAXIMUM RATINGS (T _J = 25°C unless otherwise stated)					
Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	-60	V
Gate-to-Source Voltage			V _{GS}	±20	V
Continuous Drain		T _A = 25°C	I _D	-5.7	А
Current R _{θJA} (Note 1)		$T_A = 100^{\circ}C$		-4.0	
Power Dissipation $R_{\theta JA}$		T _A = 25°C	PD	3.2	W
(Note 1)	Steady	T _A = 100°C		1.6	
Continuous Drain	State	T _C = 25°C	I _D	-20	А
Current R _{0JC} (Note 1)		$T_{C} = 100^{\circ}C$		-14	
Power Dissipation		$T_C = 25^{\circ}C$	PD	40	W
R _{θJC} (Note 1)		T _C = 100°C		20	
Pulsed Drain Current	t _p = 10 μs		I _{DM}	-76	Α
Operating Junction and Storage Temperature			T _J , T _{stg}	–55 to +175	°C
Source Current (Body Diode)			I _S	-20	А
Single Pulse Drain-to-Source Ava- L = 0.1 mH		E _{AS}	45	mJ	
lanche Energy			I _{AS}	30	А
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Note 1)	$R_{ extsf{ heta}JC}$	3.8	°C/W
Junction-to-Ambient - Steady State (Note 1)	$R_{ hetaJA}$	47	

1. Surface-mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [2 oz] including traces.

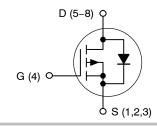


ON Semiconductor®

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V _{(BR)DSS}	R _{DS(on)} MAX	I _D MAX
–60 V	52 mΩ @ −10 V	–20 A
	72 mΩ @ –4.5 V	-20 A

P-Channel MOSFET



MARKING DIAGRAM 1 0 St bο 5116 WDFN8 st sd AYWW= (µ8FL) CASE 511AB G bΟ 5116 = Specific Device Code = Assembly Location А

	,	
Y	= Year	
WW	= Work Week	

= Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

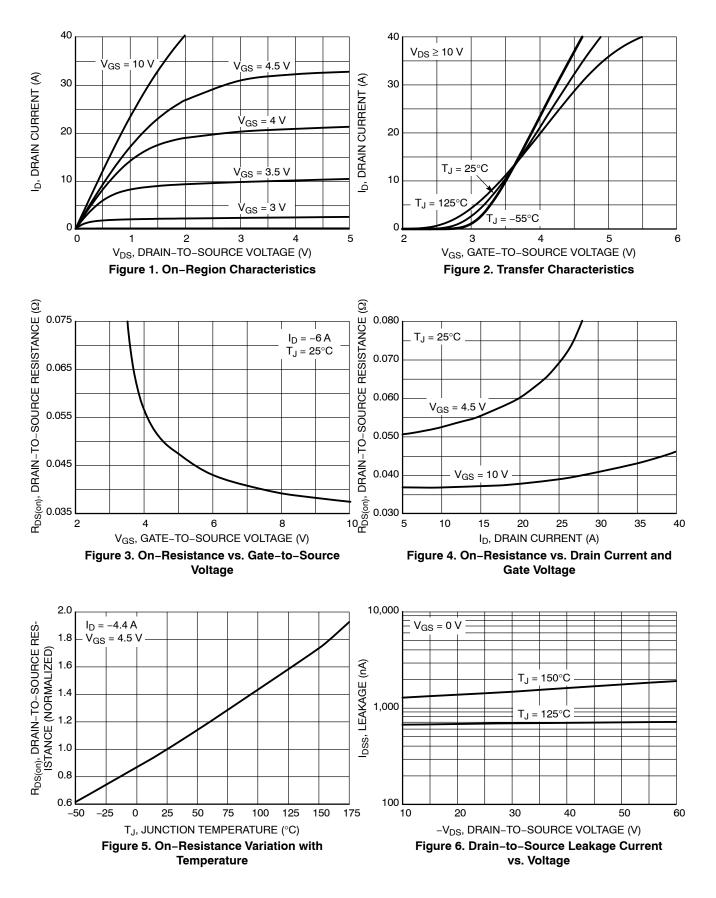
Device	Package	Shipping [†]
NTTFS5116PLTAG	WDFN8 (Pb-Free)	1500/Tape & Reel
NTTFS5116PLTWG	WDFN8 (Pb-Free)	5000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

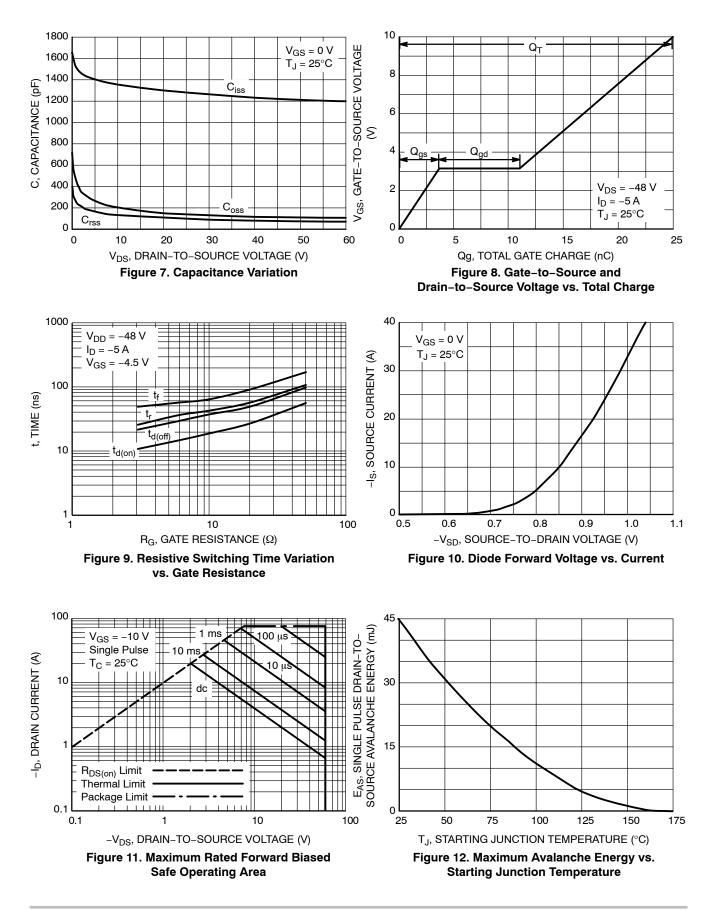
ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	-	•			-	-	-
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = -250 μA		-60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				69.7		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = -60 V	$T_J = 25^{\circ}C$			-1.0	μΑ
			$T_J = 125^{\circ}C$			-100	
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{GS}$	= ±20 V			±100	nA
ON CHARACTERISTICS (Note 2)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D =$	–250 μA	-1		-3	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-6.2		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = -10 V	I _D = -6 A		37	52	mΩ
		V _{GS} = -4.5 V	I _D = -4.4 A		51	72	
Forward Transconductance	g fs	V _{DS} = -15 V, I _E) = -6 A		11		S
CHARGES, CAPACITANCES AND G	ATE RESISTAI	NCE					
Input Capacitance	C _{iss}				1258		pF
Output Capacitance	C _{oss}	V _{GS} = 0 V, f = 1.0 MH	z, V _{DS} = –30 V		127		1
Reverse Transfer Capacitance	C _{rss}				84		
Total Gate Charge	Q _{G(TOT)}	$V_{GS} = -10$ V, $V_{DS} = -48$ V, $I_D = -5$ A $V_{GS} = -4.5$ V, $V_{DS} = -48$ V, $I_D = -5$ A			25		nC
					14		
Threshold Gate Charge	Q _{G(TH)}				1		nC
Gate-to-Source Charge	Q _{GS}				4		
Gate-to-Drain Charge	Q _{GD}	V_{GS} = -4.5 V, V_{DS} = -	48 V, I _D = –5 A		7		
Plateau Voltage	V _{GP}				3.1		V
Gate Resistance	R _G				5.3		Ω
SWITCHING CHARACTERISTICS (No	ote 3)						
Turn-On Delay Time	t _{d(on)}				15		ns
Rise Time	t _r	V _{GS} = -4.5 V, V _D	s = −48 V.		58		
Turn-Off Delay Time	t _{d(off)}	$V_{GS} = -4.3 \text{ V}, V_{DS} = -40 \text{ V},$ $I_D = -5 \text{ A}, \text{ R}_G = 6 \Omega$			30		
Fall Time	t _f				37		
DRAIN-SOURCE DIODE CHARACTE	RISTICS						
Forward Diode Voltage	V _{SD}	$V_{GS} = 0 V,$ $I_{S} = -5 A$	T _J = 25°C		-0.79	-1.2	V
		IS = -3 A	T _J = 125°C		-0.64	ļ	
Reverse Recovery Time	t _{RR}	V_{GS} = 0 V, d _{IS} /d _t = -100 A/µs, I _S = -5 A			20		ns
Charge Time	ta				15		_
Discharge Time	t _b				5		
Reverse Recovery Charge	Q _{RR}				19		nC

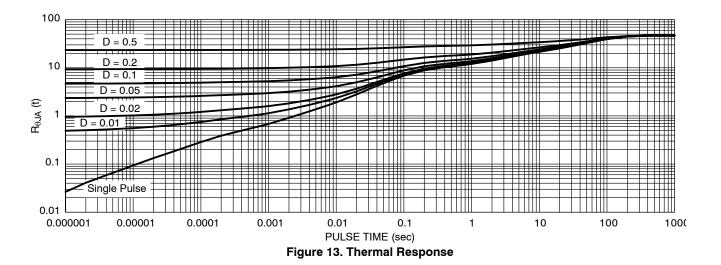
TYPICAL CHARACTERISTICS



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TYPICAL CHARACTERISTICS







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